DISCRETE SEMICONDUCTORS

DATA SHEET

BFT46N-channel silicon FET

Product specification

December 1997



BFT46

DESCRIPTION

Symmetrical n-channel silicon epitaxial planar junction field-effect transistor in a microminiature plastic envelope. The transistor is intended for low level general purpose amplifiers in thick and thin-film circuits.

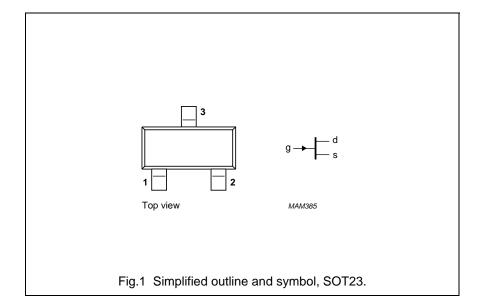
PINNING

1 = drain

2 = source

3 = gate

Note : Drain and source are interchangeable.



Marking code

BFT46 = M3p

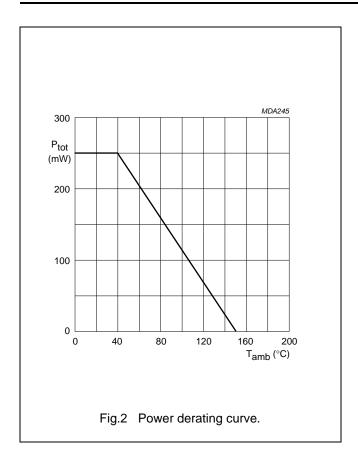
QUICK REFERENCE DATA

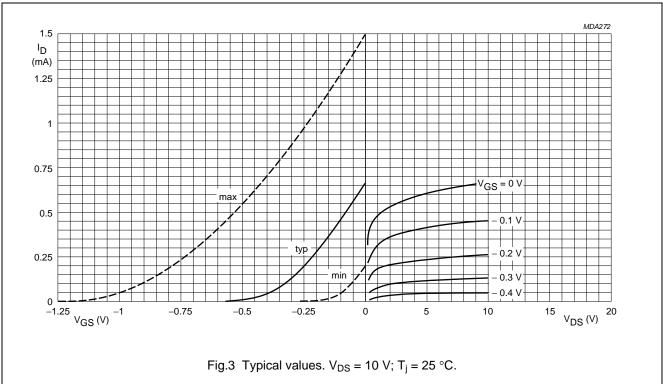
Drain-source voltage	$\pm V_{DS}$	max.	25 V
Gate-source voltage (open drain)	$-V_{GSO}$	max.	25 V
Total power dissipation up to T _{amb} = 40 °C	P_{tot}	max.	250 mW
Drain current			
$V_{DS} = 10 \text{ V}; V_{GS} = 0$	1	>	0,2 mA
	I _{DSS}		1,5 mA
Transfer admittance (common source)			
$I_D = 0.2 \text{ mA}$; $V_{DS} = 10 \text{ V}$; $f = 1 \text{ kHz}$	y _{fs}	>	0,5 mS
Equivalent noise voltage			
V_{DS} = 10 V; I_{D} = 200 μA ; B = 0,6 to 100 Hz	V_n	<	0,5 μV

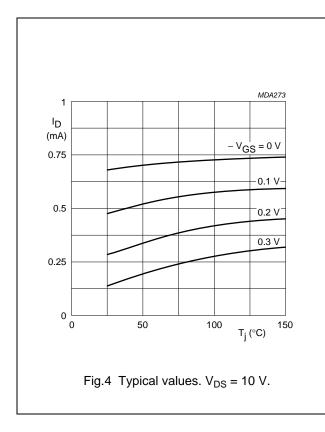
NXP Semiconductors Product specification

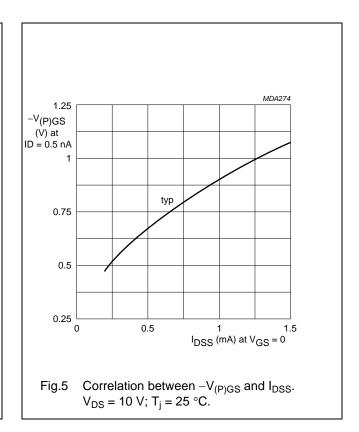
N-channel silicon FET BFT46

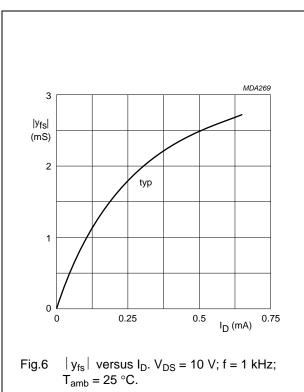
RATINGS			
Limiting values in accordance with the Absolute Maximum Sy	ystem (IEC 134)		
Drain-source voltage	$\pm V_{DS}$	max.	25 V
Drain-gate voltage (open source)	V_{DGO}	max.	25 V
Gate-source voltage (open drain)	$-V_{GSO}$	max.	25 V
Drain current	I_{D}	max.	10 mA
Gate current	I_{G}	max.	5 mA
Total power dissipation up to $T_{amb} = 40 {}^{\circ}C^{(1)}$	P_{tot}	max.	250 mW
Storage temperature range	T_{stg}	−65 to	+150 °C
Junction temperature	T_j	max.	150 °C
THERMAL RESISTANCE			
From junction to ambient ⁽¹⁾	R _{th j-a}	=	430 K/W
Note			
1. Mounted on a ceramic substrate of 8 mm \times 10 mm \times 0,7	mm.		
CHARACTERISTICS			
$T_j = 25$ °C unless otherwise specified			
Gate cut-off current			
$-V_{GS} = 10 \text{ V}; V_{DS} = 0$	-I _{GSS}	<	0,2 nA
Drain current			
$V_{DS} = 10 \text{ V}; V_{GS} = 0$	ı	>	0,2 mA
	I _{DSS}	<	1,5 mA
Gate-source voltage			
$I_D = 50 \mu A; V_{DS} = 10 V$	-V _{GS}	>	0,1 V
	-v _{GS}	<	1,0 V
Gate-source cut-off voltage			
$I_D = 0.5 \text{ nA}; V_{DS} = 10 \text{ V}$	$-V_{(P)GS}$	<	1,2 V
y-parameters at f = 1 kHz;			
$V_{DS} = 10 \text{ V}; V_{GS} = 0; T_{amb} = 25 ^{\circ}\text{C}$			
Transfer admittance	y _{fs}	>	1,0 mS
Output admittance	y _{os}	<	10 μS
V_{DS} = 10 V; I_D = 200 μ A; T_{amb} = 25 °C			
Transfer admittance	y _{fs}	>	0,5 mS
Output admittance	y _{os}	<	5 μS
Input capacitance at f = 1 MHz;			
$V_{DS} = 10 \text{ V}; V_{GS} = 0; T_{amb} = 25 ^{\circ}\text{C}$	C_{is}	<	5 pF
Feedback capacitance at f = 1 MHz;			
$V_{DS} = 10 \text{ V}; V_{GS} = 0; T_{amb} = 25 ^{\circ}\text{C}$	C_{rs}	<	1,5 pF
Equivalent noise voltage			
V_{DS} = 10 V; I_D = 200 μ A; T_{amb} = 25 °C			
B = 0.6 to 100 Hz	V_n	<	0,5 μV

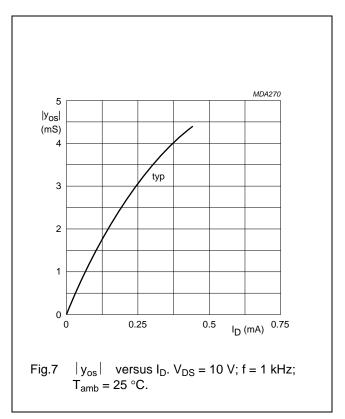


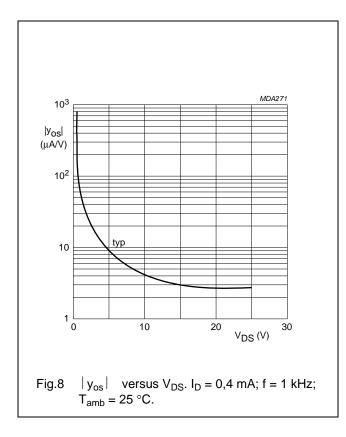


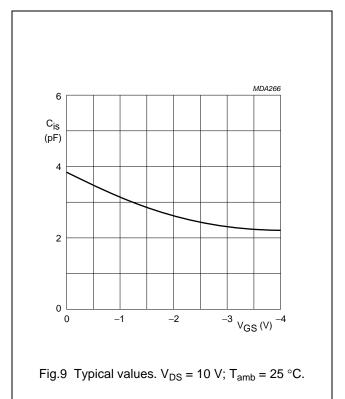


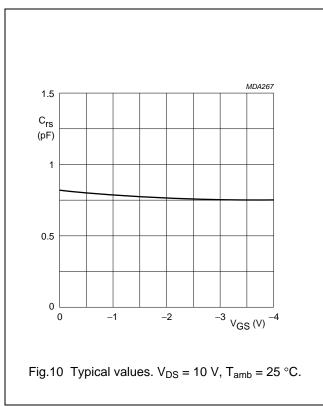


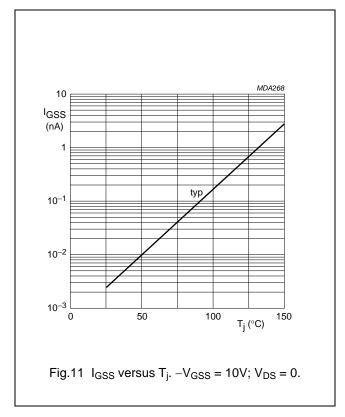


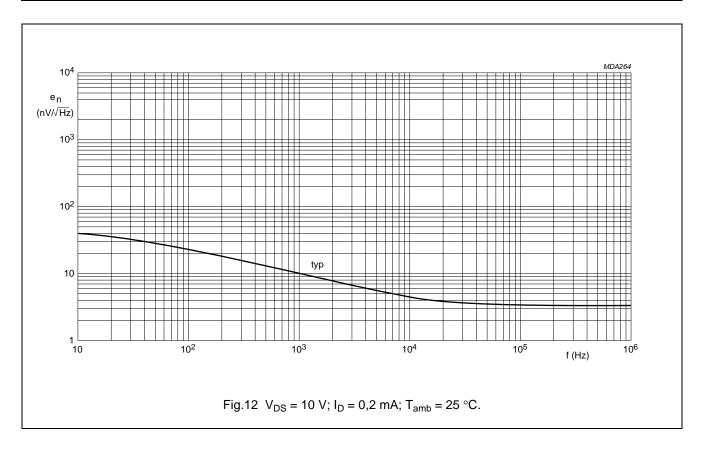


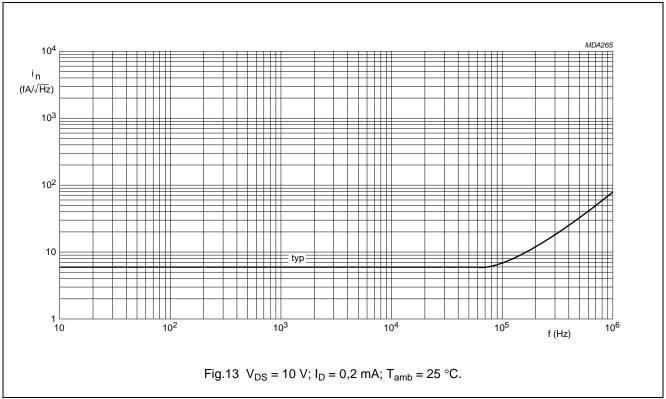










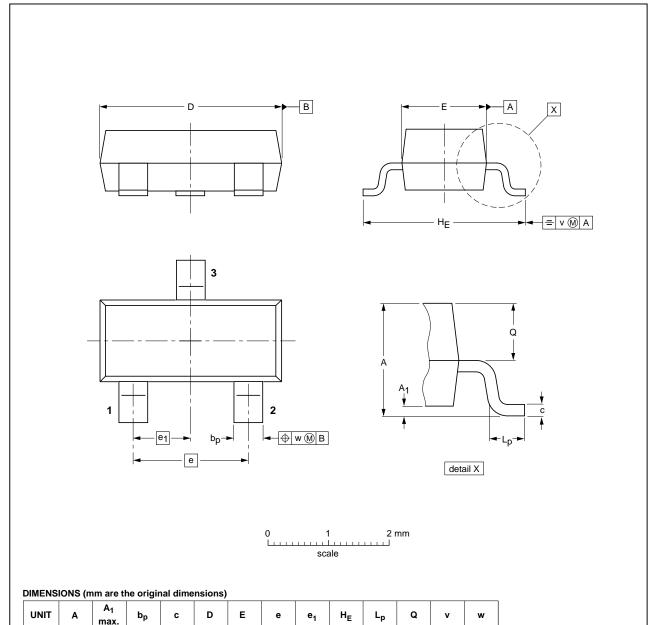


BFT46

PACKAGE OUTLINE

Plastic surface-mounted package; 3 leads

SOT23



OUTLINE	REFERENCES		EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	1330E DATE
SOT23		TO-236AB				-04-11-04 06-03-16

0.95

1.9

0.45

0.55

0.2

0.1

max.

0.1

0.48

0.38

0.15

1.1

0.9

mm

BFT46

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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NXP Semiconductors Product specification

N-channel silicon FET

BFT46

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December 1997

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Customer notification

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Contact information

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